

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	17720	kla\$.as.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 08:10
L2	713	kla\$.as.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:03
L3	0	kla\$.as. and (liao-p\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:03
L4	0	kla\$.as. and (liao-p\$ huang-b\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:04
L5	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:04
L6	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:04
L7	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:04
L8	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:05
L9	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldridge-p\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:05
L10	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:05
L11	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$ smith-l\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:05
L12	0	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$ smith-l\$ lai-f\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:05
L13	1	kla\$.as. and (liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$ smith-l\$ lai-f\$ ho-s\$ chang-e\$ bhagwat-s\$ cheung-a\$ bellon-m\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:09
L14	5482	(liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$ smith-l\$ lai-f\$ ho-s\$ chang-e\$ bhagwat-s\$ cheung-a\$ bellon-m\$).in.	US-PGPUB; USPAT	OR	ON	2006/03/07 08:09

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L15	98	(liao-p\$ huang-b\$ lai-c\$ liao-j\$ li-b\$ languev-i\$eldredge-p\$ smith-l\$ lai-f\$ ho-s\$ chang-e\$ bhagwat-s\$ cheung-a\$ bellon-m\$).in. and data adj3 analysis	US-PGPUB; USPAT	OR	ON	2006/03/07 08:09
L16	23	1 and tier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 08:18
L17	1259	semiconductor and fabrication near3 data	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:14
L18	434	semiconductor and fabrication near3 data and data and analys\$2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 08:18
L19	103	semiconductor and fabrication near3 data and data and analys\$2 and recipe	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:10
L20	692	application adj2 tier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:10
L21	4	application adj2 tier and data adj2 access adj2 tier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:11
L22	70	(semiconductor or wafer) near5 (fab or fabrication) same analys\$2 same user	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:19
L23	253	(semiconductor or wafer) near5 (fab or fabrication) and (analys\$2 same (user or designer or engineer) same (select\$3 or chosen or choos\$3))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:20

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L24	0	(semiconductor or wafer) near5 (fab or fabrication) and (analys\$2 same (user or designer or engineer) same (select\$3 or chosen or choos\$3)) and application near3 tier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:20
L25	31	(semiconductor or wafer) near5 (fab or fabrication) and (analys\$2 same (user or designer or engineer) same (select\$3 or chosen or choos\$3)) and application near3 server	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 09:20